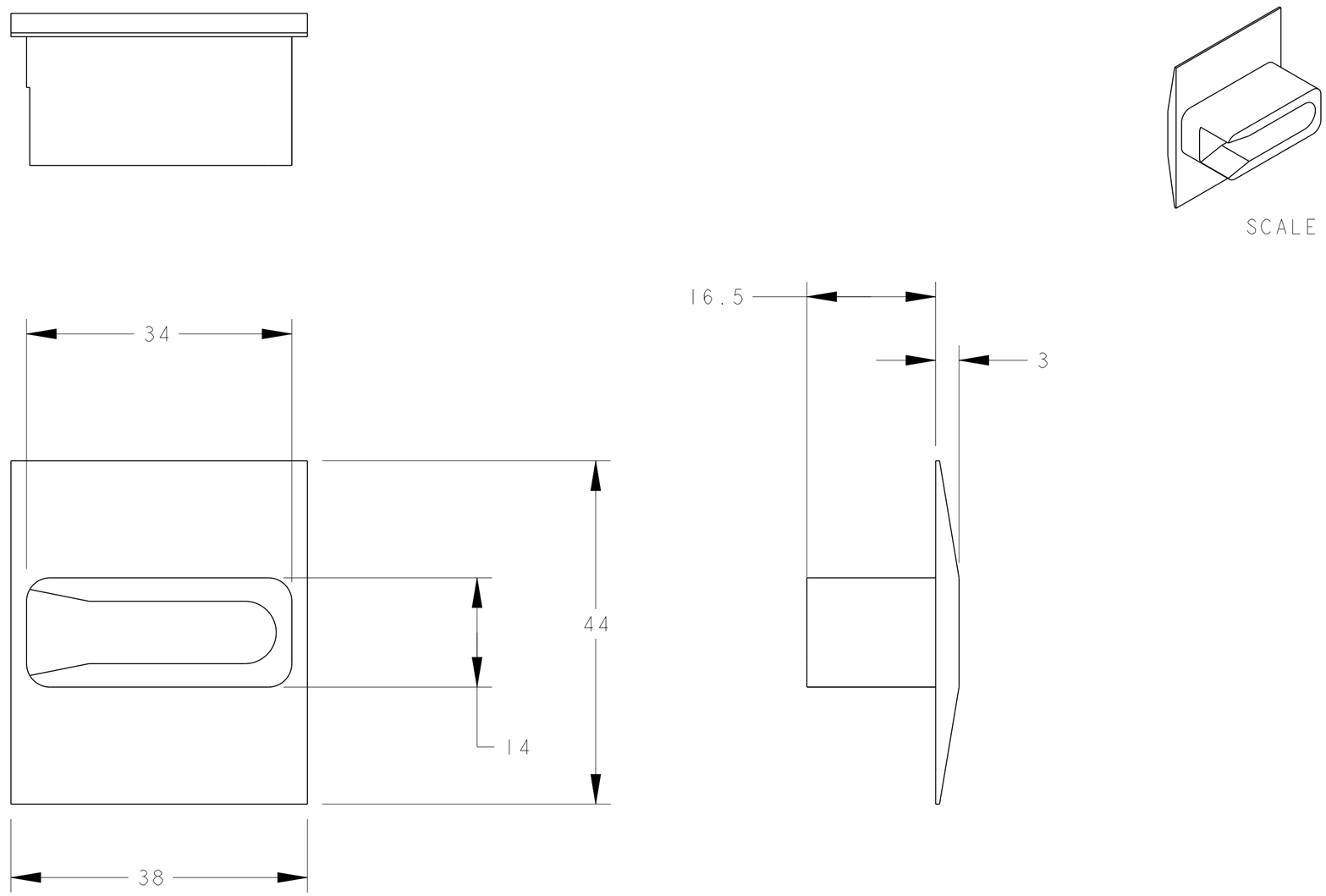
DESCRIPTION	MATERIAL	MAT. LOCATION
-	Ti 6Al4V	-



REV	DWG	CHK	ZONE	DATE	CHANGES

UNLESS OTHERWISE SPECIFIED

TOLERANCES		
	X.X ± 0.5	FRAC. ± 1/64
	X.XX ± 0.05	Angles ± 1.00°
	X.XXX ± 0.010	FINISH 125 (μin)

DO NOT SCALE PRINT

THREADS ARE CLASS 2
CHAMFER ENDS OF ALL SCREW TREADS 30°
CUT ROUND, 1.5 THREAD RELIEF ON MACHINED THREADS
BREAK EDGES .016 MAX. ON MACHINED WORK
REMOVE BURRS, WELD SPLATTER & LOOSE SCALE
IN ACCORDANCE WITH ASME Y14.5M & B46.1

SHOP ORDERS

ACCT NO.	NO. REQD	SER NO.	-
DEL TO		DATE ISSD	-
SURFACE TREATMT	-	DATE REQD	-
IDENT METHOD	TAG		
PROJECT NUMBER	N/A	US ATLAS SILICON SUBSYSTEM (logo)	
PROJECT NAME	US ATLAS SILICON SUBSYSTEM		
DWG BY	ANDERSSEN	DATE	15-Feb-03
CHK BY	HARTMAN	DATE	
APR BY	GILCHRIESE	DATE	

ERNEST ORLANDO LAWRENCE BERKELEY NATIONAL LABORATORY
UNIVERSITY OF CALIFORNIA - BERKELEY

ATLAS PIXEL DETECTOR
PIXEL SUPPORT TUBE
PIXEL MOUNT BLOCK GENERIC

MICROFILMED:	DWG. TYPE	SHOWN ON	SCALE: 2/1	DO NOT SCALE PRINTS
	PART		SHEET 1 OF 1	
PATENT CLEAR:	DESIGN ACCT. NO.	CATEGORY CODE	DWG. NO. SIZE	REV.
	PIAPII	AP6300	2501303	

DWG. NO. 2501303 SIZE REV. SH. 1

Dwg. File: 250130 Model File: GENERIC_PIXEL_MOUNT_BLOCK

Rev. 1/8/2001 ATLAS